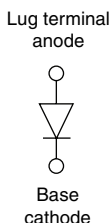


# HEXFRED® Ultrafast Soft Recovery Diode, 275 A


**HALF-PAK (D-67)**


## FEATURES

- Very low  $Q_{rr}$  and  $t_{rr}$
- Lead (Pb)-free
- Designed and qualified for industrial level

## BENEFITS

- Reduced RFI and EMI
- Reduced snubbing

## DESCRIPTION

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and  $dI/dt$  simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.


**RoHS**  
COMPLIANT

## PRODUCT SUMMARY

|                      |                 |
|----------------------|-----------------|
| $I_F$ (maximum)      | 275 A           |
| $V_R$                | 400 V           |
| $I_{F(DC)}$ at $T_C$ | 138 A at 100 °C |

## ABSOLUTE MAXIMUM RATINGS

| PARAMETER  | SYMBOL         | TEST CONDITIONS  | VALUES        | UNITS |
|--|----------------|--|---------------|-------|
| Cathode to anode voltage                         | $V_R$          |  | 400           | V     |
| Continuous forward current                       | $I_F$          | $T_C = 25\text{ °C}$   | 275           | A     |
|  |                | $T_C = 100\text{ °C}$  | 138           |       |
| Single pulse forward current                     | $I_{FSM}$      | Limited by junction temperature                                    | 900           |       |
| Non-repetitive avalanche energy                  | $E_{AS}$       | $L = 100\text{ }\mu\text{H}$ , duty cycle limited by maximum $T_J$ | 1.4           | mJ    |
| Maximum power dissipation                        | $P_D$          | $T_C = 25\text{ °C}$   | 463           | W     |
|  |                | $T_C = 100\text{ °C}$  | 185           |       |
| Operating junction and storage temperature range | $T_J, T_{Stg}$ |  | - 55 to + 150 | °C    |

## ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)

| PARAMETER                          | SYMBOL   | TEST CONDITIONS                             |            | MIN. | TYP. | MAX. | UNITS |
|------------------------------------|----------|---|------------|------|------|------|-------|
| Cathode to anode breakdown voltage | $V_{BR}$ | $I_R = 100\text{ }\mu\text{A}$              |            | 400  | -    | -    | V     |
| Maximum forward voltage            | $V_{FM}$ | $I_F = 135\text{ A}$                        | See fig. 1 | -    | 1.06 | 1.65 |       |
|                                    |          | $I_F = 270\text{ A}$                        |            | -    | 1.2  | 2.0  |       |
|                                    |          | $I_F = 135\text{ A}, T_J = 125\text{ °C}$   |            | -    | 0.96 | 1.58 |       |
| Maximum reverse leakage current    | $I_{RM}$ | $T_J = 125\text{ °C}, V_R = 400\text{ V}$   | See fig. 2 | -    | -    | 3    | mA    |
| Junction capacitance               | $C_T$    | $V_R = 200\text{ V}$                        | See fig. 3 | -    | 280  | 380  | pF    |
| Series inductance                  | $L_S$    | From top of terminal hole to mounting plane |            | -    | 6.0  | -    | nH    |

| DYNAMIC RECOVERY CHARACTERISTICS ( $T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified) |                  |                                     |      |      |      |                  |
|---|------------------|-------------------------------------|------|------|------|------------------|
| PARAMETER   | SYMBOL           | TEST CONDITIONS                     | MIN. | TYP. | MAX. | UNITS            |
| Reverse recovery time<br>See fig. 5   | $t_{rr}$         | $T_J = 25\text{ }^{\circ}\text{C}$  | -    | 77   | 120  | ns               |
|   |                  | $T_J = 125\text{ }^{\circ}\text{C}$ | -    | 280  | 440  |                  |
| Peak recovery current<br>See fig. 6   | $I_{RRM}$        | $T_J = 25\text{ }^{\circ}\text{C}$  | -    | 7.5  | 14   | A                |
|   |                  | $T_J = 125\text{ }^{\circ}\text{C}$ | -    | 15   | 30   |                  |
| Reverse recovery charge<br>See fig. 7   | $Q_{rr}$         | $T_J = 25\text{ }^{\circ}\text{C}$  | -    | 150  | 780  | nC               |
|   |                  | $T_J = 125\text{ }^{\circ}\text{C}$ | -    | 2800 | 6300 |                  |
| Peak rate of recovery current<br>See fig. 8   | $di_{(rec)M}/dt$ | $T_J = 25\text{ }^{\circ}\text{C}$  | -    | 350  | -    | A/ $\mu\text{s}$ |
|   |                  | $T_J = 125\text{ }^{\circ}\text{C}$ | -    | 300  | -    |                  |

| THERMAL - MECHANICAL SPECIFICATIONS            |         |                                      |  |             |                     |
|--|---------|--------------------------------------|--|-------------|---------------------|
| PARAMETER                                      |         | SYMBOL                               | TEST CONDITIONS                            | VALUES      | UNITS               |
| Maximum junction and storage temperature range |         | T <sub>J</sub> ,<br>T <sub>Stg</sub> |  | - 55 to 150 | °C                  |
| Maximum thermal resistance, junction to case   |         | R <sub>thJC</sub>                    | DC operation<br>See fig. 4                 | 0.27        | °C/W                |
| Typical thermal resistance, case to heatsink   |         | R <sub>thCS</sub>                    | Mounting surface, flat, smooth and greased | 0.05        |                     |
| Approximate weight                             |         |                                      |  | 30          | g                   |
|  |         |                                      |  | 1.06        | oz.                 |
| Mounting torque                                | minimum |                                      |  | 3 (26.5)    | N · m<br>(lbf · in) |
|  | maximum |                                      |  | 4 (35.4)    |                     |
| Terminal torque                                | minimum |                                      |  | 3.4 (30)    |                     |
|  | maximum |                                      |  | 5 (44.2)    |                     |
| Case style                                     |         |                                      | HALF-PAK module                            |             |                     |



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HFA135NH40PbF

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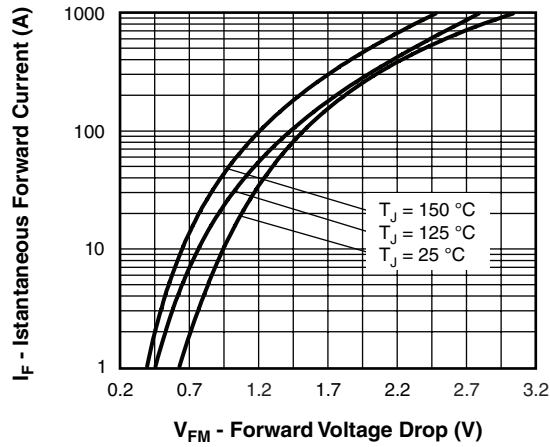


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

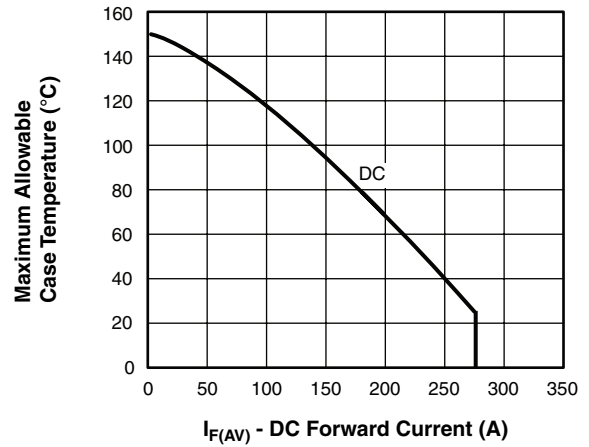


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current

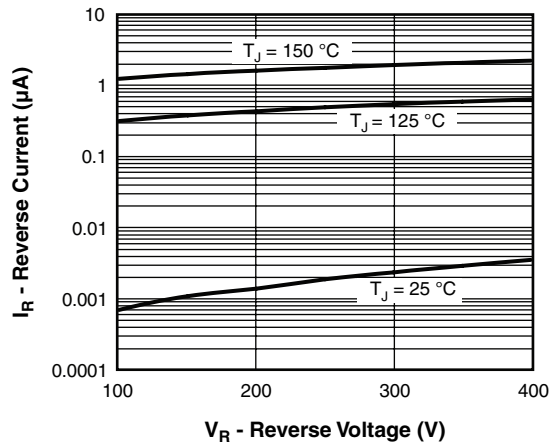


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

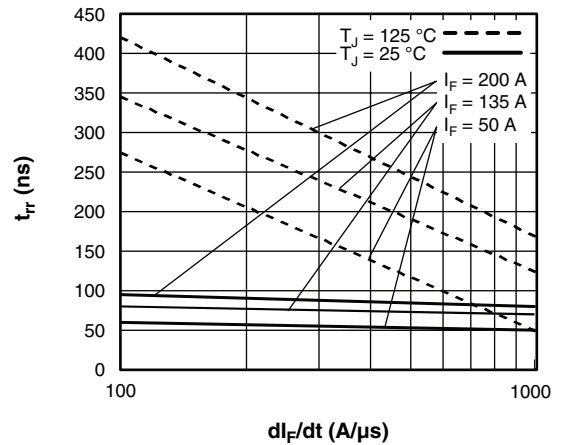


Fig. 5 - Typical Reverse Recovery Time vs.  $dI_F/dt$

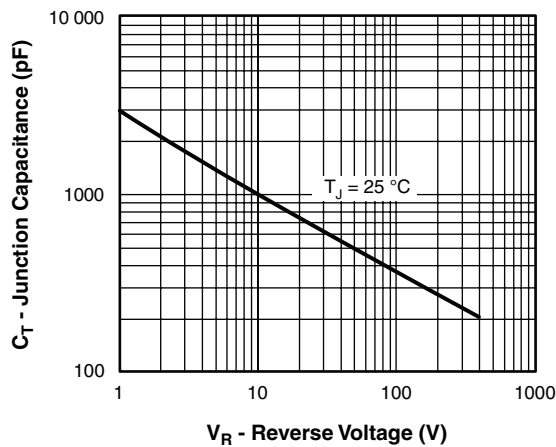


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

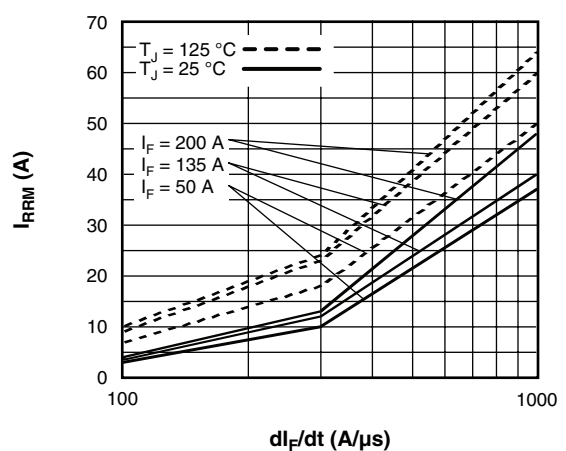


Fig. 6 - Typical Recovery Current vs.  $dI_F/dt$

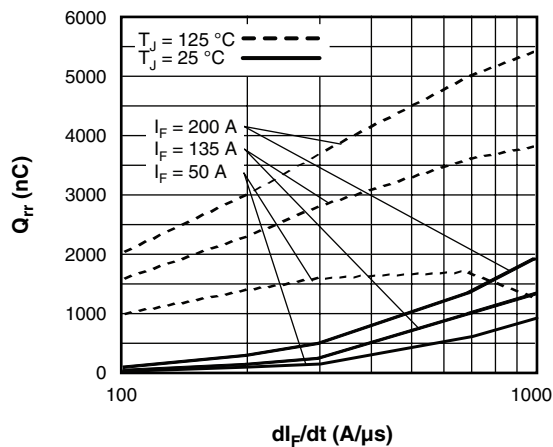


Fig. 7 - Typical Stored Charge vs.  $dI_F/dt$

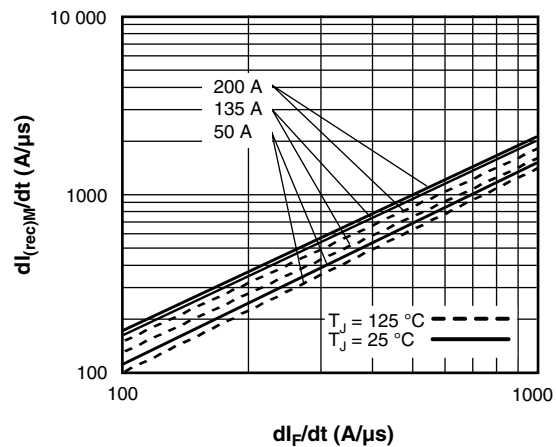


Fig. 8 - Typical  $dI_{(rec)M}/dt$  vs.  $dI_F/dt$

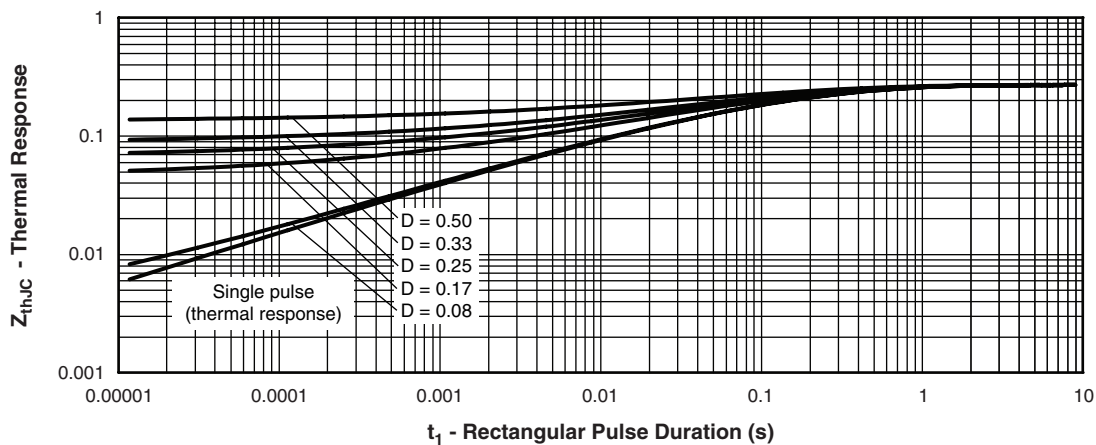


Fig. 9 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

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275 A

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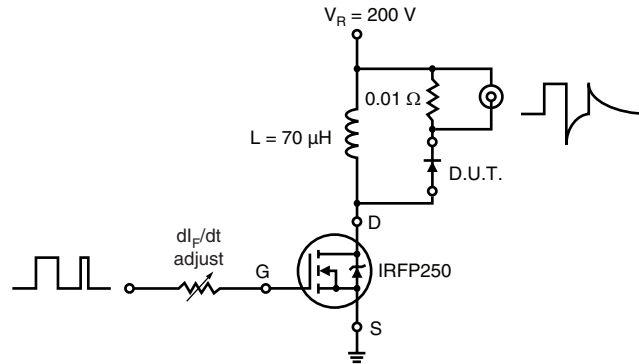
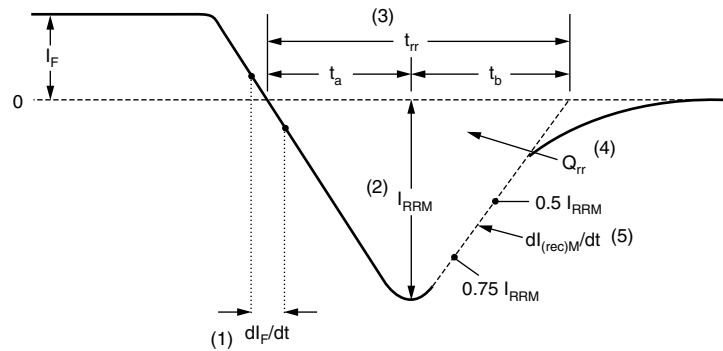


Fig. 10 - Reverse Recovery Parameter Test Circuit



(1)  $dl_F/dt$  - rate of change of current through zero crossing

(2)  $I_{RRM}$  - peak reverse recovery current

(3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current.

(4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5)  $dl_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

Fig. 11 - Reverse Recovery Waveform and Definitions

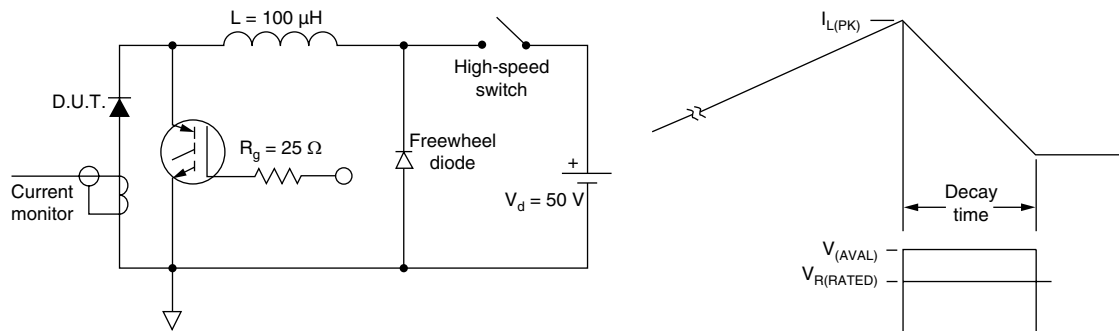


Fig. 12 - Avalanche Test Circuit and Waveforms

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**Device code**

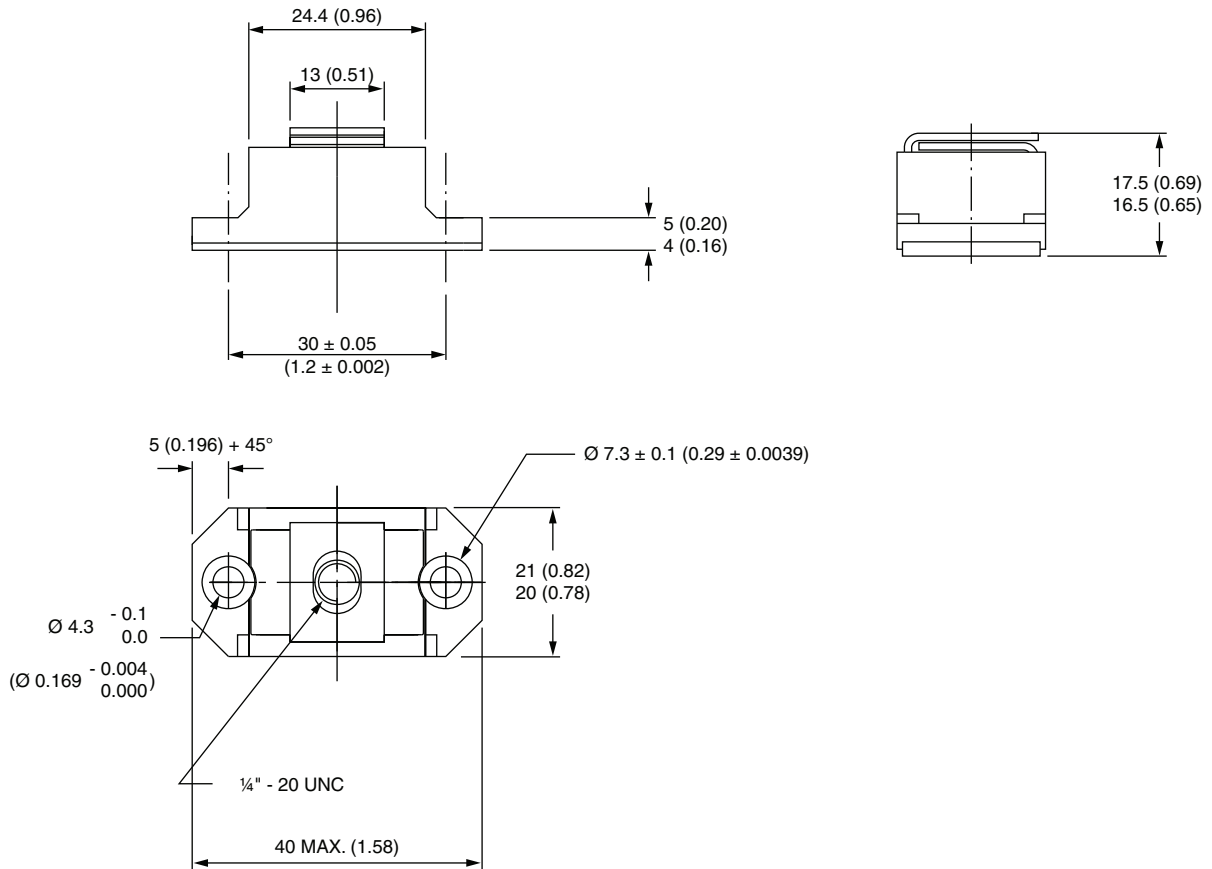
- 1** - HEXFRED® family
- 2** - Average current rating
- 3** - N = Not isolated
- 4** - H = HALF-PAK
- 5** - Voltage rating (400 V)
- 6** - Lead (Pb)-free

## Dimensions

<http://www.vishay.com/doc?95020>

## D-67 HALF-PAK

**DIMENSIONS** in millimeters (inches)





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